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LPC435x/3x/2x/1x

32-bit ARM Cortex-M4/M0 MCU; up to 1 MB flash and 136 kB SRAM; Ethernet, two High-speed USB, LCD, EMC

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Product data sheet

1. General description

The LPC435X_3X_2X_1X are ARM Cortex-M4 based microcontrollers with Floating Point Unit (FPU) for embedded applications which include an ARM Cortex-M0 coprocessor, up to 1 MB of flash and 136 kB of on-chip SRAM, 16 kB of EEPROM memory, two high-speed USB controllers, Ethernet, LCD, an external memory controller, a quad SPI Flash Interface (SPIFI) that supports execute-in-place, advanced configurable peripherals such as the State Configurable Timer (SCTimer/PWM) and the Serial General Purpose I/O (SGPIO) interface, and multiple digital and analog peripherals. The LPC435X_3X_2X_1X operate at CPU frequencies of up to 204 MHz.

The ARM Cortex-M4 is a 32-bit core that offers system enhancements such as low power consumption, enhanced debug features, and a high level of support block integration. The ARM Cortex-M4 CPU incorporates a 3-stage pipeline, uses a Harvard architecture with separate local instruction and data buses as well as a third bus for peripherals, and includes an internal prefetch unit that supports speculative branching. The ARM Cortex-M4 supports single-cycle digital signal processing and SIMD instructions. A hardware floating-point processor is integrated into the core.

The ARM Cortex-M0 coprocessor is an energy-efficient and easy-to-use 32-bit core, which is upward code- and tool-compatible with the Cortex-M4 core. It is ideal for handling control or peripheral handling to free up the Cortex-M4 for real-time processing. The Cortex-M0 coprocessor offers up to 204 MHz performance with a simple instruction set and reduced code size. In LPC43xx, the Cortex-M0 coprocessor hardware multiply is implemented as a 32-cycle iterative multiplier.

For additional documentation related to the LPC43xx parts, see [Section 17](#).

2. Features and benefits

- Cortex-M4 Processor core
 - ◆ ARM Cortex-M4 processor (version r0p1), running at frequencies of up to 204 MHz.
 - ◆ Built-in Memory Protection Unit (MPU) supporting eight regions.
 - ◆ Built-in Nested Vectored Interrupt Controller (NVIC).
 - ◆ Hardware floating-point unit.
 - ◆ Non-maskable Interrupt (NMI) input.
 - ◆ JTAG and Serial Wire Debug (SWD), serial trace, eight breakpoints, and four watch points.
 - ◆ Enhanced Trace Module (ETM) and Enhanced Trace Buffer (ETB) support.
 - ◆ System tick timer.



- Cortex-M0 Processor core
 - ◆ ARM Cortex-M0 co-processor (version r0p0) capable of off-loading the main ARM Cortex-M4 application processor.
 - ◆ Running at frequencies of up to 204 MHz.
 - ◆ JTAG
 - ◆ Built-in NVIC.
- On-chip memory
 - ◆ Up to 1 MB on-chip dual bank flash memory with flash accelerator.
 - ◆ 16 kB on-chip EEPROM data memory.
 - ◆ 136 kB SRAM for code and data use.
 - ◆ Multiple SRAM blocks with separate bus access. Two SRAM blocks can be powered down individually.
 - ◆ 64 kB ROM containing boot code and on-chip software drivers.
 - ◆ 64 bit+ 256 bit of One-Time Programmable (OTP) memory for general-purpose use.
- Configurable digital peripherals
 - ◆ Serial GPIO (SGPIO) interface.
 - ◆ State Configurable Timer (SCTimer/PWM) subsystem on AHB.
 - ◆ Global Input Multiplexer Array (GIMA) allows to cross-connect multiple inputs and outputs to event driven peripherals like the timers, SCTimer/PWM, and ADC0/1.
- Serial interfaces
 - ◆ Quad SPI Flash Interface (SPIFI) with four lanes and up to 52 MB per second.
 - ◆ 10/100T Ethernet MAC with RMII and MII interfaces and DMA support for high throughput at low CPU load. Support for IEEE 1588 time stamping/advanced time stamping (IEEE 1588-2008 v2).
 - ◆ One High-speed USB 2.0 Host/Device/OTG interface with DMA support and on-chip high-speed PHY.
 - ◆ One High-speed USB 2.0 Host/Device interface with DMA support, on-chip full-speed PHY and ULPI interface to external high-speed PHY.
 - ◆ USB interface electrical test software included in ROM USB stack.
 - ◆ One 550 UART with DMA support and full modem interface.
 - ◆ Three 550 USARTs with DMA and synchronous mode support and a smart card interface conforming to ISO7816 specification. One USART with IrDA interface.
 - ◆ Up to two C_CAN 2.0B controllers with one channel each.
 - ◆ Two SSP controllers with FIFO and multi-protocol support. Both SSPs with DMA support.
 - ◆ One SPI controller.
 - ◆ One Fast-mode Plus I²C-bus interface with monitor mode and with open-drain I/O pins conforming to the full I²C-bus specification. Supports data rates of up to 1 Mbit/s.
 - ◆ One standard I²C-bus interface with monitor mode and with standard I/O pins.
 - ◆ Two I²S interfaces, each with DMA support and with one input and one output.
- Digital peripherals
 - ◆ External Memory Controller (EMC) supporting external SRAM, ROM, NOR flash, and SDRAM devices.

- ◆ LCD controller with DMA support and a programmable display resolution of up to 1024 H × 768 V. Supports monochrome and color STN panels and TFT color panels; supports 1/2/4/8 bpp Color Look-Up Table (CLUT) and 16/24-bit direct pixel mapping. Available on parts LPC4357/53 only.
- ◆ Secure Digital Input Output (SD/MMC) card interface.
- ◆ Eight-channel General-Purpose DMA controller can access all memories on the AHB and all DMA-capable AHB slaves.
- ◆ Up to 164 General-Purpose Input/Output (GPIO) pins with configurable pull-up/pull-down resistors.
- ◆ GPIO registers are located on the AHB for fast access. GPIO ports have DMA support.
- ◆ Up to eight GPIO pins can be selected from all GPIO pins as edge and level sensitive interrupt sources.
- ◆ Two GPIO group interrupt modules enable an interrupt based on a programmable pattern of input states of a group of GPIO pins.
- ◆ Four general-purpose timer/counters with capture and match capabilities.
- ◆ One motor control Pulse Width Modulator (PWM) for three-phase motor control.
- ◆ One Quadrature Encoder Interface (QEI).
- ◆ Repetitive Interrupt timer (RI timer).
- ◆ Windowed watchdog timer (WWDT).
- ◆ Ultra-low power Real-Time Clock (RTC) on separate power domain with 256 bytes of battery powered backup registers.
- ◆ Alarm timer; can be battery powered.
- Analog peripherals
 - ◆ One 10-bit DAC with DMA support and a data conversion rate of 400 kSamples/s.
 - ◆ Two 10-bit ADCs with DMA support and a data conversion rate of 400 kSamples/s. Up to eight input channels per ADC.
- Unique ID for each device.
- Clock generation unit
 - ◆ Crystal oscillator with an operating range of 1 MHz to 25 MHz.
 - ◆ 12 MHz internal RC oscillator trimmed to 3 % accuracy over temperature and voltage (1.5 % accuracy for $T_{amb} = 0\text{ °C}$ to 85 °C).
 - ◆ Ultra-low power Real-Time Clock (RTC) crystal oscillator.
 - ◆ Three PLLs allow CPU operation up to the maximum CPU rate without the need for a high-frequency crystal. The second PLL can be used with the High-speed USB, the third PLL can be used as audio PLL.
 - ◆ Clock output.
- Power
 - ◆ Single 3.3 V (2.4 V to 3.6 V) power supply with on-chip DC-to-DC converter for the core supply and the RTC power domain.
 - ◆ RTC power domain can be powered separately by a 3 V battery supply.
 - ◆ Four reduced power modes: Sleep, Deep-sleep, Power-down, and Deep power-down.
 - ◆ Processor wake-up from Sleep mode via wake-up interrupts from various peripherals.

- ◆ Wake-up from Deep-sleep, Power-down, and Deep power-down modes via external interrupts and interrupts generated by battery powered blocks in the RTC power domain.
- ◆ Brownout detect with four separate thresholds for interrupt and forced reset.
- ◆ Power-On Reset (POR).
- Available as LQFP208, LQFP144, LBGA256, or TFBGA100 packages.

3. Applications

- Motor control
- Power management
- White goods
- RFID readers
- Embedded audio applications
- Industrial automation
- e-metering

4. Ordering information

Table 1. Ordering information

Type number	Package		Version
	Name	Description	
LPC4357FET256	LBGA256	Plastic low profile ball grid array package; 256 balls; body 17 × 17 × 1 mm	SOT740-2
LPC4357JET256	LBGA256	Plastic low profile ball grid array package; 256 balls; body 17 × 17 × 1 mm	SOT740-2
LPC4357JBD208	LQFP208	Plastic low profile quad flat package; 208 leads; body 28 × 28 × 1.4 mm	SOT459-1
LPC4353FET256	LBGA256	Plastic low profile ball grid array package; 256 balls; body 17 × 17 × 1 mm	SOT740-2
LPC4353JET256	LBGA256	Plastic low profile ball grid array package; 256 balls; body 17 × 17 × 1 mm	SOT740-2
LPC4353JBD208	LQFP208	Plastic low profile quad flat package; 208 leads; body 28 × 28 × 1.4 mm	SOT459-1
LPC4337FET256	LBGA256	Plastic low profile ball grid array package; 256 balls; body 17 × 17 × 1 mm	SOT740-2
LPC4337JET256	LBGA256	Plastic low profile ball grid array package; 256 balls; body 17 × 17 × 1 mm	SOT740-2
LPC4337JBD144	LQFP144	Plastic low profile quad flat package; 144 leads; body 20 × 20 × 1.4 mm	SOT486-1
LPC4337JET100	TFBGA100	Plastic thin fine-pitch ball grid array package; 100 balls; body 9 × 9 × 0.7 mm	SOT926-1
LPC4333FET256	LBGA256	Plastic low profile ball grid array package; 256 balls; body 17 × 17 × 1 mm	SOT740-2
LPC4333JET256	LBGA256	Plastic low profile ball grid array package; 256 balls; body 17 × 17 × 1 mm	SOT740-2
LPC4333JBD144	LQFP144	Plastic low profile quad flat package; 144 leads; body 20 × 20 × 1.4 mm	SOT486-1
LPC4333JET100	TFBGA100	Plastic thin fine-pitch ball grid array package; 100 balls; body 9 × 9 × 0.7 mm	SOT926-1
LPC4327JBD144	LQFP144	Plastic low profile quad flat package; 144 leads; body 20 × 20 × 1.4 mm	SOT486-1
LPC4327JET100	TFBGA100	Plastic thin fine-pitch ball grid array package; 100 balls; body 9 × 9 × 0.7 mm	SOT926-1
LPC4325JBD144	LQFP144	Plastic low profile quad flat package; 144 leads; body 20 × 20 × 1.4 mm	SOT486-1
LPC4325JET100	TFBGA100	Plastic thin fine-pitch ball grid array package; 100 balls; body 9 × 9 × 0.7 mm	SOT926-1
LPC4323JBD144	LQFP144	Plastic low profile quad flat package; 144 leads; body 20 × 20 × 1.4 mm	SOT486-1
LPC4323JET100	TFBGA100	Plastic thin fine-pitch ball grid array package; 100 balls; body 9 × 9 × 0.7 mm	SOT926-1
LPC4322JBD144	LQFP144	Plastic low profile quad flat package; 144 leads; body 20 × 20 × 1.4 mm	SOT486-1
LPC4322JET100	TFBGA100	Plastic thin fine-pitch ball grid array package; 100 balls; body 9 × 9 × 0.7 mm	SOT926-1
LPC4317JBD144	LQFP144	Plastic low profile quad flat package; 144 leads; body 20 × 20 × 1.4 mm	SOT486-1
LPC4317JET100	TFBGA100	Plastic thin fine-pitch ball grid array package; 100 balls; body 9 × 9 × 0.7 mm	SOT926-1
LPC4315JBD144	LQFP144	Plastic low profile quad flat package; 144 leads; body 20 × 20 × 1.4 mm	SOT486-1
LPC4315JET100	TFBGA100	Plastic thin fine-pitch ball grid array package; 100 balls; body 9 × 9 × 0.7 mm	SOT926-1
LPC4313JBD144	LQFP144	Plastic low profile quad flat package; 144 leads; body 20 × 20 × 1.4 mm	SOT486-1
LPC4313JET100	TFBGA100	Plastic thin fine-pitch ball grid array package; 100 balls; body 9 × 9 × 0.7 mm	SOT926-1
LPC4312JBD144	LQFP144	Plastic low profile quad flat package; 144 leads; body 20 × 20 × 1.4 mm	SOT486-1
LPC4312JET100	TFBGA100	Plastic thin fine-pitch ball grid array package; 100 balls; body 9 × 9 × 0.7 mm	SOT926-1

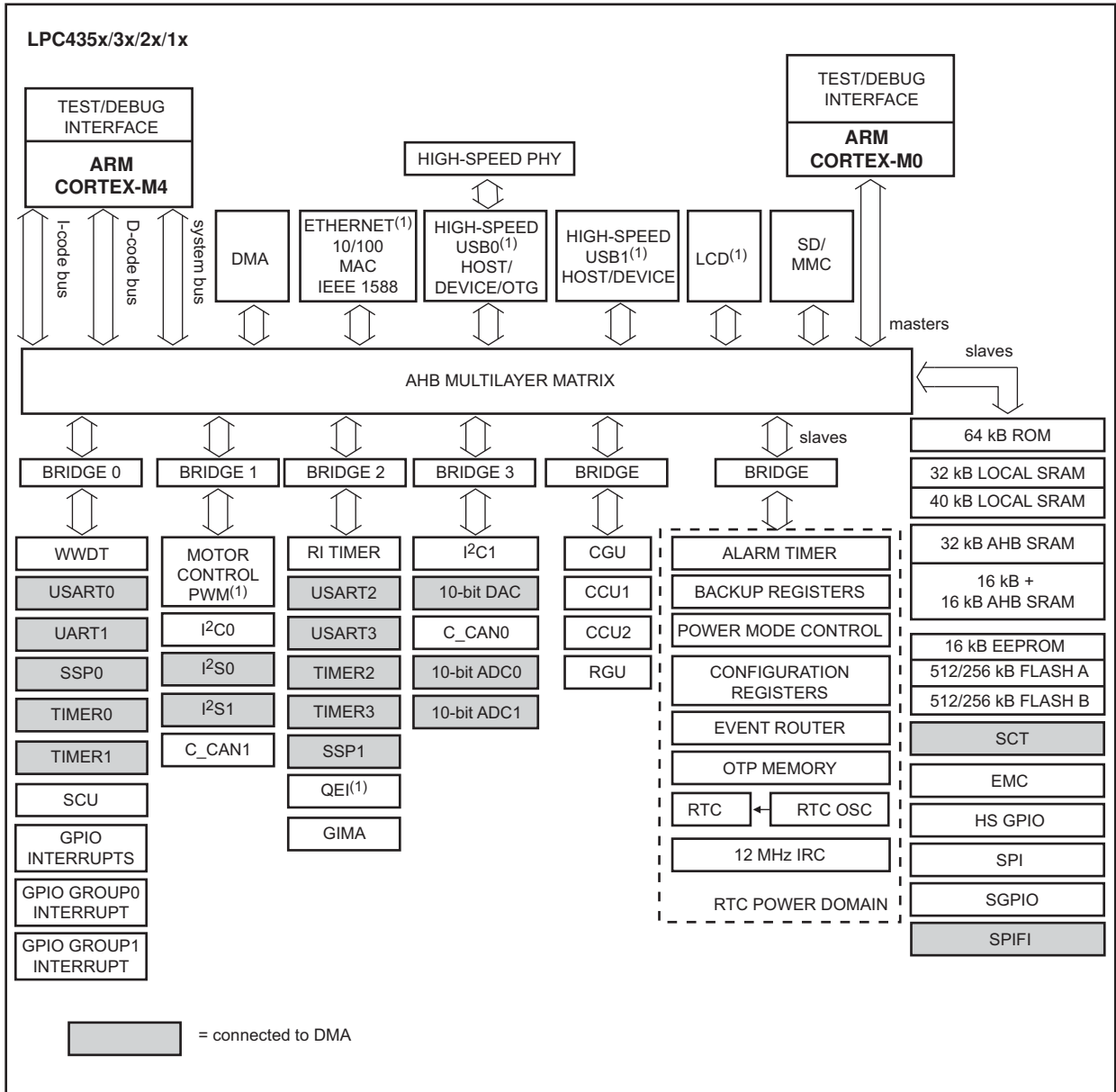
4.1 Ordering options

Table 2. Ordering options

Type number	Flash total	Flash bank A	Flash bank B	Total SRAM	LCD	Ethernet	USB0 (Host, Device, OTG)	USB1 (Host, Device)/ ULPI interface	Motor control PWM	QEI	ADC channels	Temperature range ^[1]	GPIO
LPC4357FET256	1 MB	512 kB	512 kB	136 kB	yes	yes	yes	yes/yes	yes	yes	8	F	164
LPC4357JET256	1 MB	512 kB	512 kB	136 kB	yes	yes	yes	yes/yes	yes	yes	8	J	164
LPC4357JBD208	1 MB	512 kB	512 kB	136 kB	yes	yes	yes	yes/yes	yes	yes	8	J	142
LPC4353FET256	512 kB	256 kB	256 kB	136 kB	yes	yes	yes	yes/yes	yes	yes	8	F	164
LPC4353JET256	512 kB	256 kB	256 kB	136 kB	yes	yes	yes	yes/yes	yes	yes	8	J	164
LPC4353JBD208	512 kB	256 kB	256 kB	136 kB	yes	yes	yes	yes/yes	yes	yes	8	J	142
LPC4337FET256	1 MB	512 kB	512 kB	136 kB	no	yes	yes	yes/yes	yes	yes	8	F	164
LPC4337JET256	1 MB	512 kB	512 kB	136 kB	no	yes	yes	yes/yes	yes	yes	8	J	164
LPC4337JBD144	1 MB	512 kB	512 kB	136 kB	no	yes	yes	yes/yes	yes	no	8	J	83
LPC4337JET100	1 MB	512 kB	512 kB	136 kB	no	yes	yes	yes/no	no	no	4	J	49
LPC4333FET256	512 kB	256 kB	256 kB	136 kB	no	yes	yes	yes/yes	yes	yes	8	F	164
LPC4333JET256	512 kB	256 kB	256 kB	136 kB	no	yes	yes	yes/yes	yes	yes	8	J	164
LPC4333JBD144	512 kB	256 kB	256 kB	136 kB	no	yes	yes	yes/yes	yes	no	8	J	83
LPC4333JET100	512 kB	256 kB	256 kB	136 kB	no	yes	yes	yes/no	no	no	4	J	49
LPC4327JBD144	1 MB	512 kB	512 kB	136 kB	no	no	yes	no/no	yes	no	8	J	83
LPC4327JET100	1 MB	512 kB	512 kB	136 kB	no	no	yes	no/no	no	no	4	J	49
LPC4325JBD144	768 kB	384 kB	384 kB	136 kB	no	no	yes	no/no	yes	no	8	J	83
LPC4325JET100	768 kB	384 kB	384 kB	136 kB	no	no	yes	no/no	no	no	4	J	49
LPC4323JBD144	512 kB	256 kB	256 kB	104 kB	no	no	yes	no/no	yes	no	8	J	83
LPC4323JET100	512 kB	256 kB	256 kB	104 kB	no	no	yes	no/no	no	no	4	J	49
LPC4322JBD144	512 kB	512 kB	0 kB	104 kB	no	no	yes	no/no	yes	no	8	J	83
LPC4322JET100	512 kB	512 kB	0 kB	104 kB	no	no	yes	no/no	no	no	4	J	49
LPC4317JBD144	1 MB	512 kB	512 kB	136 kB	no	no	no	no/no	yes	no	8	J	83
LPC4317JET100	1 MB	512 kB	512 kB	136 kB	no	no	no	no/no	no	no	4	J	49
LPC4315JBD144	768 kB	384 kB	384 kB	136 kB	no	no	no	no/no	yes	no	8	J	83
LPC4315JET100	768 kB	384 kB	384 kB	136 kB	no	no	no	no/no	no	no	4	J	49
LPC4313JBD144	512 kB	256 kB	256 kB	104 kB	no	no	no	no/no	yes	no	8	J	83
LPC4313JET100	512 kB	256 kB	256 kB	104 kB	no	no	no	no/no	no	no	4	J	49
LPC4312JBD144	512 kB	512 kB	0 kB	104 kB	no	no	no	no/no	yes	no	8	J	83
LPC4312JET100	512 kB	512 kB	0 kB	104 kB	no	no	no	no/no	no	no	4	J	49

[1] J = -40 °C to +105 °C; F = -40 °C to +85 °C.

5. Block diagram



002aah234

(1) Not available on all parts. See Table 2.

Fig 1. LPC435x/3x/2x/1x Block diagram

6. Pinning information

6.1 Pinning

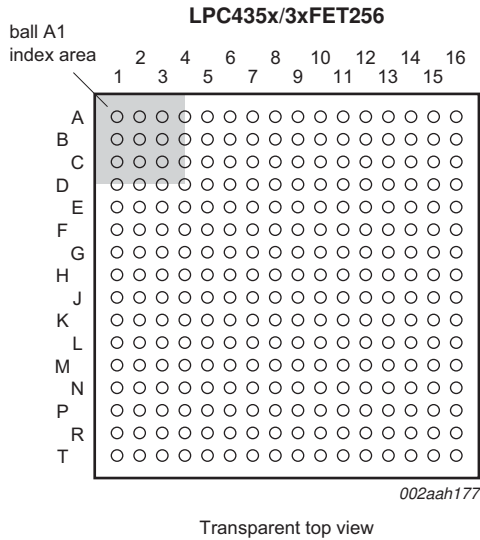


Fig 2. Pin configuration LQFP256 package

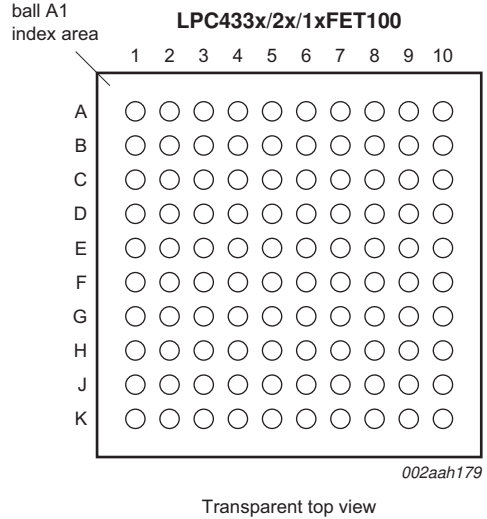


Fig 3. Pin configuration TFBGA100 package

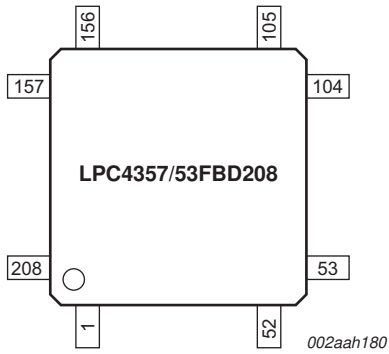


Fig 4. Pin configuration LQFP208 package

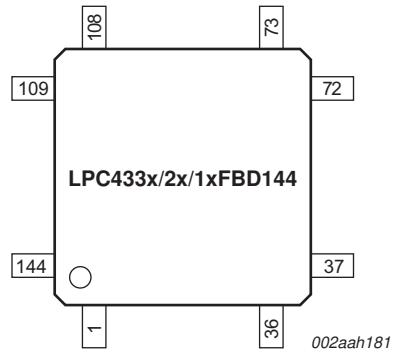


Fig 5. Pin configuration LQFP144 package

6.2 Pin description

On the LPC435x/3x/2x/1x, digital pins are grouped into 16 ports, named P0 to P9 and PA to PF, with up to 20 pins used per port. Each digital pin can support up to eight different digital functions, including General Purpose I/O (GPIO), selectable through the System Configuration Unit (SCU) registers. The pin name is not indicative of the GPIO port assigned to it.

The parts contain two 10-bit ADCs (ADC0 and ADC1). The input channels of ADC0 and ADC1 on dedicated pins and multiplexed pins are combined in such a way that all channel 0 inputs (named ADC0_0 and ADC1_0) are tied together and connected to both, channel 0 on ADC0 and channel 0 on ADC1, channel 1 inputs (named ADC0_1 and ADC1_1) are tied together and connected to channel 1 on ADC0 and ADC1, and so forth. There are eight ADC channels total for the two ADCs.

Table 3. Pin description

Pin name	LQFP208	LQFP144	LBGA256	TFBGA100	Reset state [2]	Type	Description	
Multiplexed digital pins								
P0_0	L3	G2	47	32	[2]	N; PU	I/O	GPIO0[0] — General purpose digital input/output pin.
							I/O	SSP1_MISO — Master In Slave Out for SSP1.
							I	ENET_RXD1 — Ethernet receive data 1 (RMII/MII interface).
							I/O	SGPIO0 — General purpose digital input/output pin.
							-	R — Function reserved.
							-	R — Function reserved.
							I/O	I2S0_TX_WS — Transmit Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the <i>I²S-bus specification</i> .
I/O	I2S1_TX_WS — Transmit Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the <i>I²S-bus specification</i> .							
P0_1	M2	G1	50	34	[2]	N; PU	I/O	GPIO0[1] — General purpose digital input/output pin.
							I/O	SSP1_MOSI — Master Out Slave in for SSP1.
							I	ENET_COL — Ethernet Collision detect (MII interface).
							I/O	SGPIO1 — General purpose digital input/output pin.
							-	R — Function reserved.
							-	R — Function reserved.
							I/O	ENET_TX_EN — Ethernet transmit enable (RMII/MII interface).
I/O	I2S1_TX_SDA — I2S1 transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the <i>I²S-bus specification</i> .							
P1_0	P2	H1	54	38	[2]	N; PU	I/O	GPIO0[4] — General purpose digital input/output pin.
							I	CTIN_3 — SCT input 3. Capture input 1 of timer 1.
							I/O	EMC_A5 — External memory address line 5.
							-	R — Function reserved.
							-	R — Function reserved.
							I/O	SSP0_SSEL — Slave Select for SSP0.
							I/O	SGPIO7 — General purpose digital input/output pin.
I/O	EMC_D12 — External memory data line 12.							

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [2]	Type	Description
P1_1	R2	K2	58	42	[2]	N; PU	I/O	GPIO0[8] — General purpose digital input/output pin. Boot pin (see Table 5).
							O	CTOUT_7 — SCT output 7. Match output 3 of timer 1.
							I/O	EMC_A6 — External memory address line 6.
							I/O	SGPIO8 — General purpose digital input/output pin.
							-	R — Function reserved.
							I/O	SSP0_MISO — Master In Slave Out for SSP0.
							-	R — Function reserved.
							I/O	EMC_D13 — External memory data line 13.
P1_2	R3	K1	60	43	[2]	N; PU	I/O	GPIO0[9] — General purpose digital input/output pin. Boot pin (see Table 5).
							O	CTOUT_6 — SCT output 6. Match output 2 of timer 1.
							I/O	EMC_A7 — External memory address line 7.
							I/O	SGPIO9 — General purpose digital input/output pin.
							-	R — Function reserved.
							I/O	SSP0_MOSI — Master Out Slave in for SSP0.
							-	R — Function reserved.
							I/O	EMC_D14 — External memory data line 14.
P1_3	P5	J1	61	44	[2]	N; PU	I/O	GPIO0[10] — General purpose digital input/output pin.
							O	CTOUT_8 — SCT output 8. Match output 0 of timer 2.
							I/O	SGPIO10 — General purpose digital input/output pin.
							O	EMC_OE — LOW active Output Enable signal.
							O	USB0_IND1 — USB0 port indicator LED control output 1.
							I/O	SSP1_MISO — Master In Slave Out for SSP1.
							-	R — Function reserved.
							O	SD_RST — SD/MMC reset signal for MMC4.4 card.
P1_4	T3	J2	64	47	[2]	N; PU	I/O	GPIO0[11] — General purpose digital input/output pin.
							O	CTOUT_9 — SCT output 9. Match output 3 of timer 3.
							I/O	SGPIO11 — General purpose digital input/output pin.
							O	EMC_BLS0 — LOW active Byte Lane select signal 0.
							O	USB0_IND0 — USB0 port indicator LED control output 0.
							I/O	SSP1_MOSI — Master Out Slave in for SSP1.
							I/O	EMC_D15 — External memory data line 15.
							O	SD_VOLT1 — SD/MMC bus voltage select output 1.

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [2]	Type	Description
P1_5	R5	J4	65	48	[2]	N; PU	I/O	GPIO1[8] — General purpose digital input/output pin.
							O	CTOUT_10 — SCT output 10. Match output 3 of timer 3.
							-	R — Function reserved.
							O	EMC_CS0 — LOW active Chip Select 0 signal.
							I	USB0_PWR_FAULT — Port power fault signal indicating overcurrent condition; this signal monitors over-current on the USB bus (external circuitry required to detect over-current condition).
							I/O	SSP1_SSEL — Slave Select for SSP1.
							I/O	SGPIO15 — General purpose digital input/output pin.
P1_6	T4	K4	67	49	[2]	N; PU	O	SD_POW — SD/MMC power monitor output.
							I/O	GPIO1[9] — General purpose digital input/output pin.
							I	CTIN_5 — SCT input 5. Capture input 2 of timer 2.
							-	R — Function reserved.
							O	EMC_WE — LOW active Write Enable signal.
							-	R — Function reserved.
							O	EMC_BLS0 — LOW active Byte Lane select signal 0.
I/O	SGPIO14 — General purpose digital input/output pin.							
P1_7	T5	G4	69	50	[2]	N; PU	I/O	SD_CMD — SD/MMC command signal.
							I/O	GPIO1[0] — General purpose digital input/output pin.
							I	U1_DSR — Data Set Ready input for UART1.
							O	CTOUT_13 — SCT output 13. Match output 3 of timer 3.
							I/O	EMC_D0 — External memory data line 0.
							O	USB0_PPWR — VBUS drive signal (towards external charge pump or power management unit); indicates that VBUS must be driven (active HIGH). Add a pull-down resistor to disable the power switch at reset. This signal has opposite polarity compared to the USB_PPWR used on other NXP LPC parts.
							-	R — Function reserved.
-	R — Function reserved.							
-	R — Function reserved.							

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P1_8	R7	H5	71	51	[2]	N; PU	I/O	GPIO1[1] — General purpose digital input/output pin.
							O	U1_DTR — Data Terminal Ready output for UART1.
							O	CTOUT_12 — SCT output 12. Match output 3 of timer 3.
							I/O	EMC_D1 — External memory data line 1.
							-	R — Function reserved.
							-	R — Function reserved.
							O	SD_VOLT0 — SD/MMC bus voltage select output 0.
P1_9	T7	J5	73	52	[2]	N; PU	I/O	GPIO1[2] — General purpose digital input/output pin.
							O	U1_RTS — Request to Send output for UART1.
							O	CTOUT_11 — SCT output 11. Match output 3 of timer 2.
							I/O	EMC_D2 — External memory data line 2.
							-	R — Function reserved.
							-	R — Function reserved.
							I/O	SD_DAT0 — SD/MMC data bus line 0.
P1_10	R8	H6	75	53	[2]	N; PU	I/O	GPIO1[3] — General purpose digital input/output pin.
							I	U1_RI — Ring Indicator input for UART1.
							O	CTOUT_14 — SCT output 14. Match output 2 of timer 3.
							I/O	EMC_D3 — External memory data line 3.
							-	R — Function reserved.
							-	R — Function reserved.
							I/O	SD_DAT1 — SD/MMC data bus line 1.
P1_11	T9	J7	77	55	[2]	N; PU	I/O	GPIO1[4] — General purpose digital input/output pin.
							I	U1_CTS — Clear to Send input for UART1.
							O	CTOUT_15 — SCT output 15. Match output 3 of timer 3.
							I/O	EMC_D4 — External memory data line 4.
							-	R — Function reserved.
							-	R — Function reserved.
							I/O	SD_DAT2 — SD/MMC data bus line 2.

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [2]	Type	Description
P1_12	R9	K7	78	56	[2]	N; PU	I/O	GPIO1[5] — General purpose digital input/output pin.
							I	U1_DCD — Data Carrier Detect input for UART1.
							-	R — Function reserved.
							I/O	EMC_D5 — External memory data line 5.
							I	T0_CAP1 — Capture input 1 of timer 0.
							-	R — Function reserved.
							I/O	SGPIO8 — General purpose digital input/output pin.
							I/O	SD_DAT3 — SD/MMC data bus line 3.
P1_13	R10	H8	83	60	[2]	N; PU	I/O	GPIO1[6] — General purpose digital input/output pin.
							O	U1_TXD — Transmitter output for UART1.
							-	R — Function reserved.
							I/O	EMC_D6 — External memory data line 6.
							I	T0_CAP0 — Capture input 0 of timer 0.
							-	R — Function reserved.
							I/O	SGPIO9 — General purpose digital input/output pin.
							I	SD_CD — SD/MMC card detect input.
P1_14	R11	J8	85	61	[2]	N; PU	I/O	GPIO1[7] — General purpose digital input/output pin.
							I	U1_RXD — Receiver input for UART1.
							-	R — Function reserved.
							I/O	EMC_D7 — External memory data line 7.
							O	T0_MAT2 — Match output 2 of timer 0.
							-	R — Function reserved.
							I/O	SGPIO10 — General purpose digital input/output pin.
							-	R — Function reserved.
P1_15	T12	K8	87	62	[2]	N; PU	I/O	GPIO0[2] — General purpose digital input/output pin.
							O	U2_TXD — Transmitter output for USART2.
							I/O	SGPIO2 — General purpose digital input/output pin.
							I	ENET_RXD0 — Ethernet receive data 0 (RMII/MII interface).
							O	T0_MAT1 — Match output 1 of timer 0.
							-	R — Function reserved.
							I/O	EMC_D8 — External memory data line 8.
							-	R — Function reserved.

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P1_16	M7	H9	90	64	[2]	N; PU	I/O	GPIO0[3] — General purpose digital input/output pin.
							I	U2_RXD — Receiver input for USART2.
							I/O	SGPIO3 — General purpose digital input/output pin.
							I	ENET_CRS — Ethernet Carrier Sense (MII interface).
							O	T0_MAT0 — Match output 0 of timer 0.
							-	R — Function reserved.
							I/O	EMC_D9 — External memory data line 9.
							I	ENET_RX_DV — Ethernet Receive Data Valid (RMII/MII interface).
P1_17	M8	H10	93	66	[3]	N; PU	I/O	GPIO0[12] — General purpose digital input/output pin.
							I/O	U2_UCLK — Serial clock input/output for USART2 in synchronous mode.
							-	R — Function reserved.
							I/O	ENET_MDIO — Ethernet MIIM data input and output.
							I	T0_CAP3 — Capture input 3 of timer 0.
							O	CAN1_TD — CAN1 transmitter output.
							I/O	SGPIO11 — General purpose digital input/output pin.
							-	R — Function reserved.
P1_18	N12	J10	95	67	[2]	N; PU	I/O	GPIO0[13] — General purpose digital input/output pin.
							I/O	U2_DIR — RS-485/EIA-485 output enable/direction control for USART2.
							-	R — Function reserved.
							O	ENET_TXD0 — Ethernet transmit data 0 (RMII/MII interface).
							O	T0_MAT3 — Match output 3 of timer 0.
							I	CAN1_RD — CAN1 receiver input.
							I/O	SGPIO12 — General purpose digital input/output pin.
							I/O	EMC_D10 — External memory data line 10.
P1_19	M11	K9	96	68	[2]	N; PU	I	ENET_TX_CLK (ENET_REF_CLK) — Ethernet Transmit Clock (MII interface) or Ethernet Reference Clock (RMII interface).
							I/O	SSP1_SCK — Serial clock for SSP1.
							-	R — Function reserved.
							-	R — Function reserved.
							O	CLKOUT — Clock output pin.
							-	R — Function reserved.
							O	I2S0_RX_MCLK — I2S receive master clock.
							I/O	I2S1_TX_SCK — Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the I ² S-bus specification.

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [2]	Type	Description
P1_20	M10	K10	100	70	[2]	N; PU	I/O	GPIO0[15] — General purpose digital input/output pin.
							I/O	SSP1_SSEL — Slave Select for SSP1.
							-	R — Function reserved.
							O	ENET_TXD1 — Ethernet transmit data 1 (RMII/MII interface).
							I	T0_CAP2 — Capture input 2 of timer 0.
							-	R — Function reserved.
							I/O	SGPIO13 — General purpose digital input/output pin.
							I/O	EMC_D11 — External memory data line 11.
P2_0	T16	G10	108	75	[2]	N; PU	I/O	SGPIO4 — General purpose digital input/output pin.
							O	U0_TXD — Transmitter output for USART0. See Table 4 for ISP mode.
							I/O	EMC_A13 — External memory address line 13.
							O	USB0_PPWR — VBUS drive signal (towards external charge pump or power management unit); indicates that VBUS must be driven (active HIGH). Add a pull-down resistor to disable the power switch at reset. This signal has opposite polarity compared to the USB_PPWR used on other NXP LPC parts.
							I/O	GPIO5[0] — General purpose digital input/output pin.
							-	R — Function reserved.
							I	T3_CAP0 — Capture input 0 of timer 3.
							O	ENET_MDC — Ethernet MIIM clock.
P2_1	N15	G7	116	81	[2]	N; PU	I/O	SGPIO5 — General purpose digital input/output pin.
							I	U0_RXD — Receiver input for USART0. See Table 4 for ISP mode.
							I/O	EMC_A12 — External memory address line 12.
							I	USB0_PWR_FAULT — Port power fault signal indicating overcurrent condition; this signal monitors over-current on the USB bus (external circuitry required to detect over-current condition).
							I/O	GPIO5[1] — General purpose digital input/output pin.
							-	R — Function reserved.
							I	T3_CAP1 — Capture input 1 of timer 3.
							-	R — Function reserved.

Table 3. Pin description ...continued

Pin name	LBGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P2_2	M15	F5	121	84	[2]	N; PU	I/O	SGPIO6 — General purpose digital input/output pin.
							I/O	U0_UCLK — Serial clock input/output for USART0 in synchronous mode.
							I/O	EMC_A11 — External memory address line 11.
							O	USB0_IND1 — USB0 port indicator LED control output 1.
							I/O	GPIO5[2] — General purpose digital input/output pin.
							I	CTIN_6 — SCT input 6. Capture input 1 of timer 3.
							I	T3_CAP2 — Capture input 2 of timer 3.
							O	EMC_CS1 — LOW active Chip Select 1 signal.
P2_3	J12	D8	127	87	[3]	N; PU	I/O	SGPIO12 — General purpose digital input/output pin.
							I/O	I2C1_SDA — I ² C1 data input/output (this pin does not use a specialized I2C pad).
							O	U3_TXD — Transmitter output for USART3. See Table 4 for ISP mode.
							I	CTIN_1 — SCT input 1. Capture input 1 of timer 0. Capture input 1 of timer 2.
							I/O	GPIO5[3] — General purpose digital input/output pin.
							-	R — Function reserved.
							O	T3_MAT0 — Match output 0 of timer 3.
							O	USB0_PPWR — VBUS drive signal (towards external charge pump or power management unit); indicates that VBUS must be driven (active HIGH). Add a pull-down resistor to disable the power switch at reset. This signal has opposite polarity compared to the USB_PPWR used on other NXP LPC parts.
P2_4	K11	D9	128	88	[3]	N; PU	I/O	SGPIO13 — General purpose digital input/output pin.
							I/O	I2C1_SCL — I ² C1 clock input/output (this pin does not use a specialized I2C pad).
							I	U3_RXD — Receiver input for USART3. See Table 4 for ISP mode.
							I	CTIN_0 — SCT input 0. Capture input 0 of timer 0, 1, 2, 3.
							I/O	GPIO5[4] — General purpose digital input/output pin.
							-	R — Function reserved.
							O	T3_MAT1 — Match output 1 of timer 3.
							I	USB0_PWR_FAULT — Port power fault signal indicating overcurrent condition; this signal monitors over-current on the USB bus (external circuitry required to detect over-current condition).

Table 3. Pin description ...continued

Pin name	LBGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P2_5	K14	D10	131	91	[3]	N; PU	I/O	SGPIO14 — General purpose digital input/output pin.
							I	CTIN_2 — SCT input 2. Capture input 2 of timer 0.
							I	USB1_VBUS — Monitors the presence of USB1 bus power. Note: This signal must be HIGH for USB reset to occur.
							I	ADCTRIG1 — ADC trigger input 1.
							I/O	GPIO5[5] — General purpose digital input/output pin.
							-	R — Function reserved.
							O	T3_MAT2 — Match output 2 of timer 3.
							O	USB0_IND0 — USB0 port indicator LED control output 0.
P2_6	K16	G9	137	95	[2]	N; PU	I/O	SGPIO7 — General purpose digital input/output pin.
							I/O	U0_DIR — RS-485/EIA-485 output enable/direction control for USART0.
							I/O	EMC_A10 — External memory address line 10.
							O	USB0_IND0 — USB0 port indicator LED control output 0.
							I/O	GPIO5[6] — General purpose digital input/output pin.
							I	CTIN_7 — SCT input 7.
							I	T3_CAP3 — Capture input 3 of timer 3.
O	EMC_BLS1 — LOW active Byte Lane select signal 1.							
P2_7	H14	C10	138	96	[2]	N; PU	I/O	GPIO0[7] — General purpose digital input/output pin. If this pin is pulled LOW at reset, the part enters ISP mode or boots from an external source (see Table 4 and Table 5).
							O	CTOUT_1 — SCT output 1. Match output 3 of timer 3.
							I/O	U3_UCLK — Serial clock input/output for USART3 in synchronous mode.
							I/O	EMC_A9 — External memory address line 9.
							-	R — Function reserved.
							-	R — Function reserved.
							O	T3_MAT3 — Match output 3 of timer 3.
							-	R — Function reserved.
P2_8	J16	C6	140	98	[2]	N; PU	I/O	SGPIO15 — General purpose digital input/output pin. Boot pin (see Table 5).
							O	CTOUT_0 — SCT output 0. Match output 0 of timer 0.
							I/O	U3_DIR — RS-485/EIA-485 output enable/direction control for USART3.
							I/O	EMC_A8 — External memory address line 8.
							I/O	GPIO5[7] — General purpose digital input/output pin.
							-	R — Function reserved.
							-	R — Function reserved.
-	R — Function reserved.							

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P2_9	H16	B10	144	102	[2]	N; PU	I/O	GPIO1[10] — General purpose digital input/output pin. Boot pin (see Table 5).
							O	CTOUT_3 — SCT output 3. Match output 3 of timer 0.
							I/O	U3_BAUD — Baud pin for USART3.
							I/O	EMC_A0 — External memory address line 0.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
P2_10	G16	E8	146	104	[2]	N; PU	I/O	GPIO0[14] — General purpose digital input/output pin.
							O	CTOUT_2 — SCT output 2. Match output 2 of timer 0.
							O	U2_TXD — Transmitter output for USART2.
							I/O	EMC_A1 — External memory address line 1.
							-	R — Function reserved.
							-	R — Function reserved.
P2_11	F16	A9	148	105	[2]	N; PU	I/O	GPIO1[11] — General purpose digital input/output pin.
							O	CTOUT_5 — SCT output 5. Match output 3 of timer 3.
							I	U2_RXD — Receiver input for USART2.
							I/O	EMC_A2 — External memory address line 2.
							-	R — Function reserved.
							-	R — Function reserved.
P2_12	E15	B9	153	106	[2]	N; PU	I/O	GPIO1[12] — General purpose digital input/output pin.
							O	CTOUT_4 — SCT output 4. Match output 3 of timer 3.
							-	R — Function reserved.
							I/O	EMC_A3 — External memory address line 3.
							-	R — Function reserved.
							-	R — Function reserved.
	I/O	U2_UCLK — Serial clock input/output for USART2 in synchronous mode.						

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [2]	Type	Description
P2_13	C16	A10	156	108	[2]	N; PU	I/O	GPIO1[13] — General purpose digital input/output pin.
							I	CTIN_4 — SCT input 4. Capture input 2 of timer 1.
							-	R — Function reserved.
							I/O	EMC_A4 — External memory address line 4.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
P3_0	F13	A8	161	112	[2]	N; PU	I/O	I2S0_RX_SCK — I2S receive clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the <i>I²S-bus specification</i> .
							O	I2S0_RX_MCLK — I2S receive master clock.
							I/O	I2S0_TX_SCK — Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the <i>I²S-bus specification</i> .
							O	I2S0_TX_MCLK — I2S transmit master clock.
							I/O	SSP0_SCK — Serial clock for SSP0.
							-	R — Function reserved.
							-	R — Function reserved.
P3_1	G11	F7	163	114	[2]	N; PU	I/O	I2S0_TX_WS — Transmit Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the <i>I²S-bus specification</i> .
							I/O	I2S0_RX_WS — Receive Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the <i>I²S-bus specification</i> .
							I	CAN0_RD — CAN receiver input.
							O	USB1_IND1 — USB1 Port indicator LED control output 1.
							I/O	GPIO5[8] — General purpose digital input/output pin.
							-	R — Function reserved.
							O	LCD_VD15 — LCD data.
-	R — Function reserved.							

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P3_2	F11	G6	166	116	[2]	OL; PU	I/O	I2S0_TX_SDA — I2S transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the <i>I²S-bus specification</i> .
							I/O	I2S0_RX_SDA — I2S Receive data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the <i>I²S-bus specification</i> .
							O	CAN0_TD — CAN transmitter output.
							O	USB1_IND0 — USB1 Port indicator LED control output 0.
							I/O	GPIO5[9] — General purpose digital input/output pin.
							-	R — Function reserved.
							O	LCD_VD14 — LCD data.
							-	R — Function reserved.
P3_3	B14	A7	169	118	[4]	N; PU	-	R — Function reserved.
							I/O	SPI_SCK — Serial clock for SPI.
							I/O	SSP0_SCK — Serial clock for SSP0.
							O	SPIFI_SCK — Serial clock for SPIFI.
							O	CGU_OUT1 — CGU spare clock output 1.
							-	R — Function reserved.
							O	I2S0_TX_MCLK — I2S transmit master clock.
							I/O	I2S1_TX_SCK — Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the <i>I²S-bus specification</i> .
P3_4	A15	B8	171	119	[2]	N; PU	I/O	GPIO1[14] — General purpose digital input/output pin.
							-	R — Function reserved.
							-	R — Function reserved.
							I/O	SPIFI_SIO3 — I/O lane 3 for SPIFI.
							O	U1_TXD — Transmitter output for UART 1.
							I/O	I2S0_TX_WS — Transmit Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the <i>I²S-bus specification</i> .
							I/O	I2S1_RX_SDA — I2S1 Receive data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the <i>I²S-bus specification</i> .
							O	LCD_VD13 — LCD data.

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [2]	Type	Description
P3_5	C12	B7	173	121	[2]	N; PU	I/O	GPIO1[15] — General purpose digital input/output pin.
							-	R — Function reserved.
							-	R — Function reserved.
							I/O	SPIFI_SIO2 — I/O lane 2 for SPIFI.
							I	U1_RXD — Receiver input for UART 1.
							I/O	I2S0_TX_SDA — I2S transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the <i>I²S-bus specification</i> .
							I/O	I2S1_RX_WS — Receive Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the <i>I²S-bus specification</i> .
							O	LCD_VD12 — LCD data.
P3_6	B13	C7	174	122	[2]	N; PU	I/O	GPIO0[6] — General purpose digital input/output pin.
							I/O	SPI_MISO — Master In Slave Out for SPI.
							I/O	SSP0_SSEL — Slave Select for SSP0.
							I/O	SPIFI_MISO — Input 1 in SPIFI quad mode; SPIFI output IO1.
							-	R — Function reserved.
							I/O	SSP0_MISO — Master In Slave Out for SSP0.
							-	R — Function reserved.
							-	R — Function reserved.
P3_7	C11	D7	176	123	[2]	N; PU	-	R — Function reserved.
							I/O	SPI_MOSI — Master Out Slave In for SPI.
							I/O	SSP0_MISO — Master In Slave Out for SSP0.
							I/O	SPIFI_MOSI — Input IO in SPIFI quad mode; SPIFI output IO0.
							I/O	GPIO5[10] — General purpose digital input/output pin.
							I/O	SSP0_MOSI — Master Out Slave in for SSP0.
							-	R — Function reserved.
							-	R — Function reserved.
P3_8	C10	E7	179	124	[2]	N; PU	-	R — Function reserved.
							I	SPI_SSEL — Slave Select for SPI. Note that this pin in an input pin only. The SPI in master mode cannot drive the CS input on the slave. Any GPIO pin can be used for SPI chip select in master mode.
							I/O	SSP0_MOSI — Master Out Slave in for SSP0.
							I/O	SPIFI_CS — SPIFI serial flash chip select.
							I/O	GPIO5[11] — General purpose digital input/output pin.
							I/O	SSP0_SSEL — Slave Select for SSP0.
							-	R — Function reserved.
							-	R — Function reserved.

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P4_0	D5	-	1	1	[2]	N; PU	I/O	GPIO2[0] — General purpose digital input/output pin.
							O	MCOA0 — Motor control PWM channel 0, output A.
							I	NMI — External interrupt input to NMI.
							-	R — Function reserved.
							-	R — Function reserved.
							O	LCD_VD13 — LCD data.
							I/O	U3_UCLK — Serial clock input/output for USART3 in synchronous mode.
							-	R — Function reserved.
P4_1	A1	-	3	3	[5]	N; PU	I/O	GPIO2[1] — General purpose digital input/output pin.
							O	CTOUT_1 — SCT output 1. Match output 3 of timer 3.
							O	LCD_VD0 — LCD data.
							-	R — Function reserved.
							-	R — Function reserved.
							O	LCD_VD19 — LCD data.
							O	U3_TXD — Transmitter output for USART3.
							I	ENET_COL — Ethernet Collision detect (MII interface).
AI	ADC0_1 — ADC0 and ADC1, input channel 1. Configure the pin as GPIO input and use the ADC function select register in the SCU to select the ADC.							
P4_2	D3	-	12	8	[2]	N; PU	I/O	GPIO2[2] — General purpose digital input/output pin.
							O	CTOUT_0 — SCT output 0. Match output 0 of timer 0.
							O	LCD_VD3 — LCD data.
							-	R — Function reserved.
							-	R — Function reserved.
							O	LCD_VD12 — LCD data.
							I	U3_RXD — Receiver input for USART3.
							I/O	SGPIO8 — General purpose digital input/output pin.
P4_3	C2	-	10	7	[5]	N; PU	I/O	GPIO2[3] — General purpose digital input/output pin.
							O	CTOUT_3 — SCT output 3. Match output 3 of timer 0.
							O	LCD_VD2 — LCD data.
							-	R — Function reserved.
							-	R — Function reserved.
							O	LCD_VD21 — LCD data.
							I/O	U3_BAUD — Baud pin for USART3.
							I/O	SGPIO9 — General purpose digital input/output pin.
AI	ADC0_0 — DAC, ADC0 and ADC1, input channel 0. Configure the pin as GPIO input and use the ADC function select register in the SCU to select the ADC.							

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [1]	Type	Description
P4_4	B1	-	14	9	[5]	N; PU	I/O	GPIO2[4] — General purpose digital input/output pin.
							O	CTOUT_2 — SCT output 2. Match output 2 of timer 0.
							O	LCD_VD1 — LCD data.
							-	R — Function reserved.
							-	R — Function reserved.
							O	LCD_VD20 — LCD data.
							I/O	U3_DIR — RS-485/EIA-485 output enable/direction control for USART3.
							I/O	SGPIO10 — General purpose digital input/output pin.
							O	DAC — DAC output. Configure the pin as GPIO input and use the analog function select register in the SCU to select the DAC.
P4_5	D2	-	15	10	[2]	N; PU	I/O	GPIO2[5] — General purpose digital input/output pin.
							O	CTOUT_5 — SCT output 5. Match output 3 of timer 3.
							O	LCD_FP — Frame pulse (STN). Vertical synchronization pulse (TFT).
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
I/O	SGPIO11 — General purpose digital input/output pin.							
P4_6	C1	-	17	11	[2]	N; PU	I/O	GPIO2[6] — General purpose digital input/output pin.
							O	CTOUT_4 — SCT output 4. Match output 3 of timer 3.
							O	LCD_ENAB/LCDM — STN AC bias drive or TFT data enable input.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
I/O	SGPIO12 — General purpose digital input/output pin.							

Table 3. Pin description ...continued

Pin name	LPGA256	TFBGA100	LQFP208	LQFP144		Reset state [2]	Type	Description
P4_7	H4	-	21	14	[2]	O; PU	O	LCD_DCLK — LCD panel clock.
							I	GP_CLKIN — General purpose clock input to the CGU.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
							-	R — Function reserved.
							I/O	I2S1_TX_SCK — Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the I ² S-bus specification.
I/O	I2S0_TX_SCK — Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the I ² S-bus specification.							
P4_8	E2	-	23	15	[2]	N; PU	-	R — Function reserved.
							I	CTIN_5 — SCT input 5. Capture input 2 of timer 2.
							O	LCD_VD9 — LCD data.
							-	R — Function reserved.
							I/O	GPIO5[12] — General purpose digital input/output pin.
							O	LCD_VD22 — LCD data.
							O	CAN1_TD — CAN1 transmitter output.
I/O	SGPIO13 — General purpose digital input/output pin.							
P4_9	L2	-	48	33	[2]	N; PU	-	R — Function reserved.
							I	CTIN_6 — SCT input 6. Capture input 1 of timer 3.
							O	LCD_VD11 — LCD data.
							-	R — Function reserved.
							I/O	GPIO5[13] — General purpose digital input/output pin.
							O	LCD_VD15 — LCD data.
							I	CAN1_RD — CAN1 receiver input.
I/O	SGPIO14 — General purpose digital input/output pin.							
P4_10	M3	-	51	35	[2]	N; PU	-	R — Function reserved.
							I	CTIN_2 — SCT input 2. Capture input 2 of timer 0.
							O	LCD_VD10 — LCD data.
							-	R — Function reserved.
							I/O	GPIO5[14] — General purpose digital input/output pin.
							O	LCD_VD14 — LCD data.
							-	R — Function reserved.
I/O	SGPIO15 — General purpose digital input/output pin.							